

## CBR06C349C5GAC

Specifications

CBR-SMD RF COG, Ceramic, 3.4 pF, +/-0.25 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Click here for the 3D model.

| General Information      |   |
|--------------------------|---|
| Series                   | CBR-SMD RF COG                                    |
| Style                    | SMD Chip  |
| Description              | SMD, Fixed, RF, Ultra High Q,<br>Low ESR, Class I |
| Features                 | Ultra High Q, Low ESR, Class I                    |
| RoHS                     | Yes   |
| Termination              | Tin   |
| Marking                  | No  |
| AEC-Q200                 | No  |
| Typical Component Weight | 5.29 mg   |
| Notes                    | Solder Wave or Solder Reflow.                     |
| Shelf Life               | 78 Weeks  |
| MSL                      | 1   |

| Dimensions |                 |
|------------|-----------------|
| Chip Size  | 0603            |
| L          | 1.6mm +/-0.1mm  |
| W          | 0.8mm +/-0.1mm  |
| т          | 0.8mm +/-0.07mm |
| В          | 0.4mm +/-0.15mm |

4000

T&R, 180mm, Plastic Tape

| Capacitance                     | 3.4 pF              |
|---------------------------------|---------------------|
| Tolerance                       | +/-0.25 pF          |
| Voltage DC                      | 50 VDC              |
| Dielectric Withstanding Voltage | 125 VDC             |
| Temperature Range               | -55/+125°C          |
| Temp. Coefficient               | COG                 |
| Dissipation Factor              | 0.214%              |
| Aging Rate                      | 0% Loss/Decade Hour |
| Insulation Resistance           | 10 GOhms            |
| Quality Factor                  | 468                 |

| Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and  |
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**Packaging Specifications** 

Packaging Quantity

Packaging